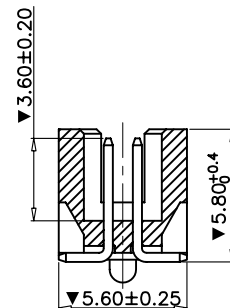
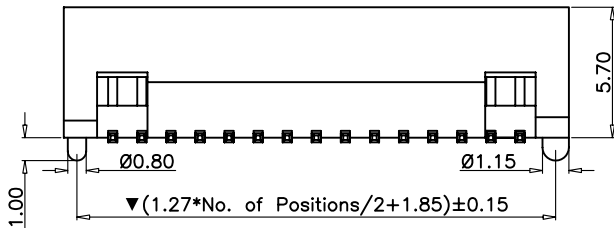
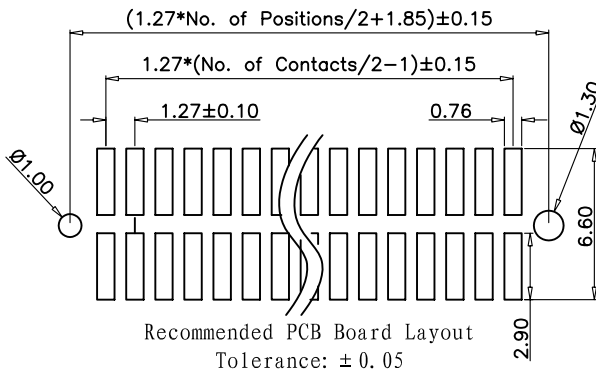
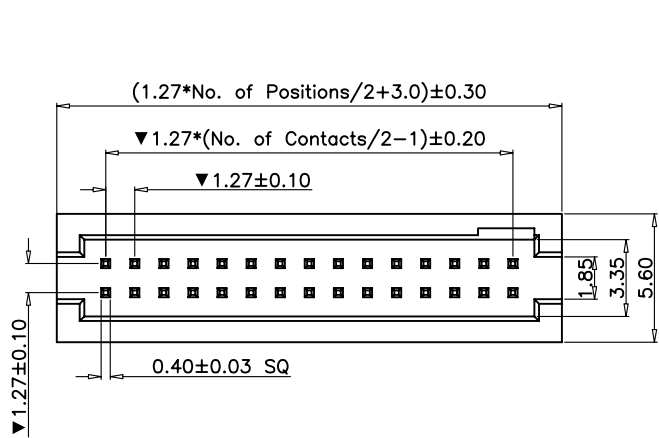




REVISION DATA				
SYM	ECN	DESCRIPTION	DATE	APPROVED



### Technical Data

#### 1.Material:

- 1.1 Contact: Brass,Au plated Over 50μ" Nickel
- 1.2 Insulator(Standard):PA6T+30%G.F,Black, UL94V-0,RoHS

#### 2.Electrical:

- 2.1 Current rating:1.5Amps/contact max.
- 2.2 Contact resistance: ≤20mΩ/contact
- 2.3 Insulation resistance: ≥1000MΩ at V=100V
- 2.4 Withstanding Voltage:450V AC/minute

#### 3.Mechanical:

- 3.1 Retention force:0.8Kgf/contact min.
- 3.2 Operaing temperature: -55°C to+105°C
- 3.3 Soldering temperature: +260°C,10s max.

#### 4.Critical Dimensions: ▼

- 5.Positions:2\*5p~2\*50p
- 6.Pin L=7.2mm

Packing	
1.General	√
2.Tape&Reel	
3.Tube	
4.Tray	
5.Other	

### Ordering information(Part No.)

<b>BED</b>	<b>XX</b>	-	<b>X</b>	<b>X</b>	<b>B</b>	<b>012</b>
No. of Positions 10~100 See note 5		Plating Option A G/F B Au3μ" C Au5μ" D Au10μ" H GF/Sn120μ" S Sn120μ" Z Special		Insulator Material Option A BK-PBT C BK-PA6T F BK-LCP S Special		Serial No. 001~999

TOLERANCE:	PROJECTION		TITLE:		
ANGLE ±2°	DATE	05-14-2010	Pitch:1.27*1.27mm Box Header SMT Type W2=5.6mm,W/ Post		
X.XXX ±0.05	DRAWN	Sullen	CUSTOMER: NA	CUSTOMER P/N: NA	REV: NA
X.XX ±0.20	CHECKED		PART NO.:	DRAWING NO.: BED-B012	REV: A
X.X ±0.30	APPROVED		SIZE: A4	UNIT: mm	SCALE: 3:1
X. ±0.40					SHEET: 1/1